

TLC5733A

20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER WITH HIGH-PRECISION CLAMP

SLAS104B – JULY 1995 – REVISED FEBRUARY 2001

- 3-Channel CMOS ADC
- 5-V Single-Supply Operation or 5-V Analog/Digital Core Supply With I/O Digital Supply From 2.7 V to 5.25 V
- 8-Bit Resolution
- Differential Linearity Error . . . ± 0.5 LSB Max
- Linearity Error . . . ± 0.75 LSB Max
- Maximum Conversion Rate
20 Megasamples per Second (MSPS) Min
- Analog Input Voltage Range
 $2 V_{I(PP)}$ Min
- 64-Pin Shrink QFP Package
- Analog Input Bandwidth . . . >14 MHz
- Suitable for YUV or RGB Applications
- Digital Clamp Optimized for NTSC or PAL YUV Component
- High-Precision Clamp . . . ± 1 LSB
- Automatic Clamp Pulse Generator
- Output-Data Format Multiplexer
- Low Power Consumption

description

The TLC5733A is a 3-channel 8-bit semiflash analog-to-digital converter (ADC) that operates from a single 5-V power supply. It converts a wide-band analog signal (such as a video signal) to digital data at sampling rates up to 20 MSPS minimum. The TLC5733A contains a feed-back type high-precision clamp circuit for each ADC channel for video (YUV) applications and a clamp pulse generator that detects COMPOSITE SYNC[†] pulses automatically. A clamp pulse can also be supplied externally. The output-data format multiplexer selects a ratio of Y:U:V of 4:4:4, 4:1:1, or 4:2:2. For RGB applications, the 4:4:4 output format without clamp function can be used. The TLC5733A is characterized for operation from -20°C to 75°C .

AVAILABLE OPTIONS

T _A	PACKAGE
	QUAD FLATPACK
-20°C to 75°C	TLC5733AIPM



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

[†] COMPOSITE SYNC refers to the externally generated synchronizing signal that is a combination of vertical and horizontal sync information used in display and TV systems.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

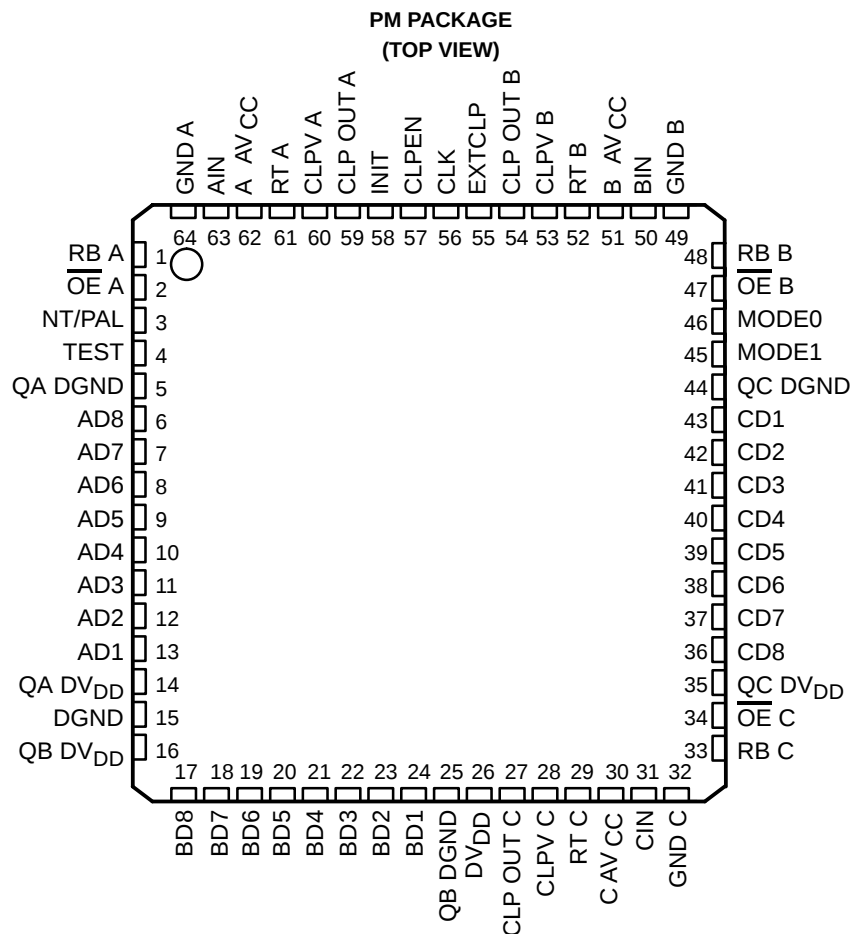
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2001, Texas Instruments Incorporated

TLC5733A

20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER WITH HIGH-PRECISION CLAMP

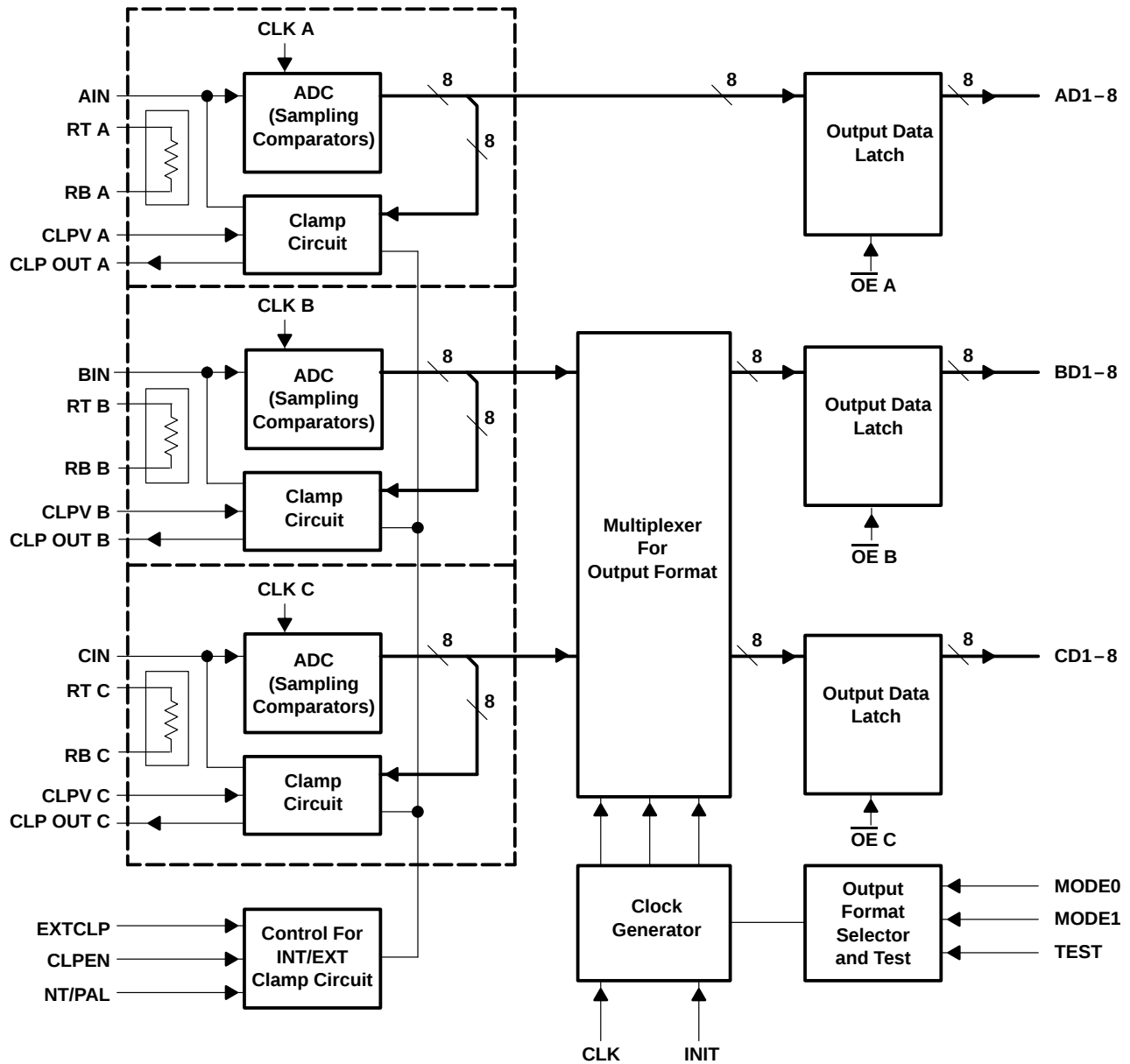
SLAS104B – JULY 1995 – REVISED FEBRUARY 2001



TLC5733A
20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER
WITH HIGH-PRECISION CLAMP

SLAS104B – JULY 1995 – REVISED FEBRUARY 2001

functional block diagram



TLC5733A

20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER

WITH HIGH-PRECISION CLAMP

SLAS104B – JULY 1995 – REVISED FEBRUARY 2001

Terminal Functions

TERMINAL NAME	NO.	I/O	DESCRIPTION
A AV_{CC}	62	I	Analog supply voltage of ADC A
AD8–AD1	6–13	O	Data output of ADC A (LSB: AD1, MSB:AD8)
AIN	63	I	Analog input of ADC A
B AV_{CC}	51	I	Analog supply voltage of ADC B
BD8–BD1	17–24	O	Data output of ADC B (LSB: BD1, MSB:BD8)
BIN	50	I	Analog input of ADC B
C AV_{CC}	30	I	Analog supply voltage of ADC C
CD8–CD1	36–43	O	Data output of ADC C (LSB:CD1, MSB: CD8) When MODE0 = L, MODE1 = L, CD8 outputs MSB flag of BD8–BD5 When MODE0 = L, MODE1 = L, CD7 outputs MSB flag of BD8–BD5 When MODE0 = L, MODE1 = H, CD8 outputs B channel flag of CD8–BD1 When MODE0 = L, MODE1 = H, CD8 outputs B channel flag of CD8–BD1
CIN	31	I	Analog input of ADC C
CLK	56	I	Clock input. The clock frequency is normally $4 \times$ the frequency subcarrier (fsc) for most video systems (see Table 3). The nominal clock frequency is 14.31818 MHz for National Television System Committee (NTSC) and 17.745 MHz for phase alteration line (PAL).
CLPEN	57	I	Clamp enable. When using an internal clamp pulse, CLPEN should be high. When using an external clamp pulse, CLPEN should be low.
CLP OUT A	59	O	Clamping bias current of ADC A. A resistor-capacitor combination that sets the clamp timing.
CLP OUT B	54	O	Clamping bias current of ADC B. A resistor-capacitor combination that sets the clamp timing.
CLP OUT C	27	O	Clamping bias current of ADC C. A resistor-capacitor combination that sets the clamp timing.
CLPV A	60	O	Clamping level of ADC A. A capacitor is connected to CLPV A to set the clamp timing. The clamp level at CLPV A is connected to an output code of 16 (0010000).
CLPV B	53	O	Clamping level of ADC B. A capacitor is connected to CLPV B to set the clamp timing. The clamp level at CLPV B is connected to an output code of 128 (1000000).
CLPV C	28	O	Clamping level of ADC C. A capacitor is connected to CLPV C to set the clamp timing. The clamp level at CLPV C is connected to an output code of 128 (1000000).
DGND	15	I	Digital ground
DVDD	26	I	Digital supply voltage
EXTCLP	55	I	External clamp pulse input. When EXTCLP and CLPEN are low, the internal clamp circuit cannot be used. The external clamp pulse when used is active high.
GND A	64	I	Ground of ADC A
GND B	49	I	Ground of ADC B
GND C	32	I	Ground of ADC C
INIT	58	I	Output initialized. The output data is synchronous when INIT is taken high from low. INIT is a control terminal that allows the external system to initialize the TLC5733A data conversion cycle. INIT is usually used at power up or system reset.
MODE0	46	I	Output format mode selector 0. When MODE1 is low and MODE0 is low, output data format1 is selected. When MODE1 is low and MODE0 is high, output data format2 is selected. When MODE1 is high and MODE0 is low, output data format3 is selected. A high level on MODE1 and a high level on MODE0 is not used.
MODE1	45	I	Output format mode selector 1. When MODE1 is low and MODE0 is low, output data format1 is selected. When MODE1 is low and MODE0 is high, output data format2 is selected. When MODE1 is high and MODE0 is low, output data format3 is selected. A high level on MODE1 and a high level on MODE0 is not used.
NT/PAL	3	I	NTSC/PAL control. NTSC/PAL should be low for NTSC and high for PAL.
$\overline{OE}$ A	2	I	Output enable A. $\overline{OE}$ A enables the output of ADC A.
$\overline{OE}$ B	47	I	Output enable B. $\overline{OE}$ B enables the output of ADC B.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

TLC5733A
20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER
WITH HIGH-PRECISION CLAMP

SLAS104B – JULY 1995 – REVISED FEBRUARY 2001

Terminal Functions (Continued)

TERMINAL NAME	NO.	I/O	DESCRIPTION
$\overline{OE}$ C	34	I	Output enable C. $\overline{OE}$ C enables the output of ADC C.
QA DGND	5	I	Digital ground for output of ADC A
QA DV _{DD}	14	I	Digital supply voltage for output of ADC A
QB DGND	25	I	Digital ground for output of ADC B
QB DV _{DD}	16	I	Digital supply voltage for output of ADC B
QC DGND	44	I	Digital ground for output of ADC C
QC DV _{DD}	35	I	Digital supply voltage for output of ADC C
RB A	1	I	Bottom reference voltage of ADC A. The nominal externally applied dc voltage between RT A and RB A is 2 V for video signals.
RB B	48	I	Bottom reference voltage of ADC B. The nominal externally applied dc voltage between RT B and RB B is 2 V for video signals.
RB C	33	I	Bottom reference voltage of ADC C. The nominal externally applied dc voltage between RT C and RB C is 2 V for video signals.
RT A	61	I	Top reference voltage of ADC A. The nominal externally applied dc voltage between RT A and RB A is 2 V for video signals.
RT B	52	I	Top reference voltage of ADC B. The nominal externally applied dc voltage between RT B and RB B is 2 V for video signals.
RT C	29		Top reference voltage of ADC C. The nominal externally applied dc voltage between RT C and RB C is 2 V for video signals.
TEST	4	I	Test. TEST should be tied low when using this device.

absolute maximum ratings[†]

Supply voltage, V _{CC} [‡] , V _{DD} [§]	7 V
Reference voltage input range, V _{ref} (RT A), V _{ref} (RT B), V _{ref} (RT C), V _{ref} (RB A), V _{ref} (RB B), V _{ref} (RB C)	AGND to V _{CC}
Analog input voltage range	AGND to V _{CC}
Digital input voltage range, V _I	DGND to V _{DD}
Digital output voltage range, V _O	DGND to V _{DD}
Operating free-air temperature range, T _A	–20°C to 75°C
Storage temperature range, T _{stg}	–55°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[‡] V_{CC} refers to all analog supplies: AAV_{CC}, BAV_{CC}, and CAV_{CC}

[§] V_{DD} refers to all digital supplies: QADV_{DD}, QBDV_{DD}, QCDV_{DD}, and DV_{DD}.



TLC5733A

20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER

WITH HIGH-PRECISION CLAMP

SLAS104B – JULY 1995 – REVISED FEBRUARY 2001

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage	$V_{CC} - AGND$	4.75	5	5.25	V
	$DV_{DD} - DGND$	4.75	5	5.25	
	$QA_{DVDD}, QB_{DVDD}, QC_{DVDD}$	2.7	3.3	5.25	
	$AGND - DGND$	-100	0	100	mV
Reference input voltage, $V_{ref(RT\ A)}, V_{ref(RT\ B)}, V_{ref(RT\ C)}$		$V_{ref(RB)} + 2$		V_{CC}	V
Reference input voltage, $V_{ref(RB\ A)}, V_{ref(RB\ B)}, V_{ref(RB\ C)}$		0	$V_{ref(RT)} - 2$		V
Analog input voltage, V_I		0	$V_{ref(RT)}$		V
High-level input voltage, V_{IH}		2			V
Low-level input voltage, V_{IL}				0.8	V
High-level pulse duration, $t_{W(H)}$		25			ns
Low-level pulse duration, $t_{W(L)}$		25			ns
Setup time for INIT input, t_{su1}		5			ns
Operating free-air temperature range, T_A		-20	75		°C

electrical characteristics at $QnDV_{DD} = 2.7\text{ V to }5.25\text{ V}$, $DV_{DD} = 5\text{ V}$, $V_{CC} = 5\text{ V}$, $V_{ref(RT)} = 2.5\text{ V}$, $V_{ref(BB)} = 0.5\text{ V}$, $f_{(CLK)} = 20\text{ MHz}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Clamp level accuracy			± 1		LSB
R_{ref} Reference voltage resistor	Measured between RT and RB	160	220	350	Ω
C_i Analog input capacitance	$V_I = 1.5\text{ V} + 0.07\text{ V}_{rms}$		16		pF
I_{IH} High-level input current	$DV_{DD} = MAX^\dagger$, $V_{CC} = 5\text{ V}$, $V_{IH} = DV_{DD}$			5	μA
I_{IL} Low-level input current	$DV_{DD} = MAX^\dagger$, $V_{CC} = 5\text{ V}$, $V_{IL} = 0$			5	
V_{OH} High-level output voltage	All $QnDV_{DD}$ terminals = $2.7\text{ V to }5.25\text{ V}$, $I_{OH} = -1\text{ mA}$	$QnDV_{DD} - 0.7\text{ V}$			V
V_{OL} Low-level output voltage	All $QnDV_{DD}$ terminals = $2.7\text{ V to }5.25\text{ V}$, $I_{OL} = 2\text{ mA}$			0.8	
$I_{OH(Ikg)}$ High-level output leakage current	$QnDV_{DD} = MAX^\dagger$, $V_{CC} = 5\text{ V}$, $V_{OH} = V_{DD}$			16	μA
$I_{OL(Ikg)}$ Low-level output leakage current	$QnDV_{DD} = MIN^\dagger$, $V_{CC} = 5\text{ V}$, $V_{OL} = 0$			16	
I_{CC} Supply current	$f_c = 20\text{ MSPS}$, NTSC ramp wave input		50	75	mA

[†] Conditions marked MIN or MAX are as stated in recommended operating conditions.



TLC5733A

20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER WITH HIGH-PRECISION CLAMP

SLAS104B – JULY 1995 – REVISED FEBRUARY 2001

operating characteristics at $Q_nDV_{DD} = 2.7\text{ V to }5.25\text{ V}$, $DV_{DD} = 5\text{ V}$, $V_{CC} = 5\text{ V}$, $V_{ref(RT)} = 2.5\text{ V}$, $V_{ref(RB)} = 0.5\text{ V}$, $f_{(CLK)} = 20\text{ MHz}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
E_{ZS} Zero-scale error	$V_{ref} = REFT - REFB = 2\text{ V}$	-18	-43	-68	mV
E_{FS} Full-scale error	$V_{ref} = REFT - REFB = 2\text{ V}$	-20	0	20	mV
E_L Linearity error	$f_{(CLK)} = 20\text{ MHz}$, $V_I = 0.5\text{ V to }2.5\text{ V}$		± 0.4	± 0.75	LSB
	$f_{(CLK)} = 20\text{ MHz}$, $T_A = -20^\circ\text{C to }75^\circ\text{C}$		± 0.4	± 1	
E_D Linearity error, differential	$f_{(CLK)} = 20\text{ MHz}$, $V_I = 0.5\text{ V to }2.5\text{ V}$		± 0.3	± 0.5	LSB
	$f_{(CLK)} = 20\text{ MHz}$, $T_A = -20^\circ\text{C to }75^\circ\text{C}$		± 0.3	± 0.75	
f_c Maximum conversion rate	$V_I = 0.5\text{ V} - 2.5\text{ V}$, $f_I = 1\text{-kHz ramp waveform}$	20			MSPS
BW Analog input bandwidth	$A_t = 1\text{ dB}$		14		MHz
t_{pd} Digital output delay time	$C_L = 10\text{ pF}$		18	30	ns
Differential gain	NTSC 40 IRE [†] modulation wave, $f_c = 14.3\text{ MSPS}$		1%		
Differential phase	NTSC 40 IRE [†] modulation wave, $f_c = 14.3\text{ MSPS}$		0.7		deg
Aperture jitter time			30		ps
Sampling delay time			4		ns

[†] Institute of Radio Engineers

detailed description

clamp function

The clamp function is optimized for a YUV video signal and has two clamp modes. The first mode uses the COMPOSITE SYNC signal as the input to the EXTCLP terminal to generate an internal clamp pulse and the second mode uses an externally generated clamp pulse as the input to the EXTCLP terminal.

In the first mode, the device detects false pulses in the COMPOSITE SYNC signal by monitoring the rising and falling edges of the COMPOSITE SYNC signal pulses. This monitoring prevents faulty operation caused by disturbances and missing pulses of the COMPOSITE SYNC signal input on EXTCLP and external spike noise. When fault pulses are detected, the device internally generates a train of clamp pulses at the proper positions (1H) by an internal 910-counter for NTSC and a 1136-counter for PAL. The device checks clamp pulses for 1H time and generates clamp pulses at correct positions when COMPOSITE SYNC pulses are in error in time.

The internal counter continually produces a horizontal sync period (1H) that is NTSC or PAL compatible as selected by the condition of the NT/PAL terminal.

clamp voltages and selection

Table 1 shows the clamping level during the clamp interval. Table 2 shows the selection of the internal or external clamp pulse. With either NTSC or PAL, the internal clamp pulse is always used.

Table 1. Clamp Level (Internal Connection Level)

CHANNEL OF ADC	OUTPUT CODE	APPLICATION
ADC A • $V_{I(A)}$	00010000	Y
ADC B • $V_{I(B)}$	10000000	(U, V)
ADC C • $V_{I(C)}$	10000000	(U, V)

TLC5733A

20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER

WITH HIGH-PRECISION CLAMP

SLAS104B – JULY 1995 – REVISED FEBRUARY 2001

clamp voltages and selection (continued)

Table 2. Clamp Level (Internal Connection Level)

CONDITION			FUNCTION (EACH ADC)	
CLPEN	EXTCLP	NT/PAL	INTERNAL CLAMP	CLAMP PULSE
L		Don't Care	Inactive	External clamp pulse
	L	Don't Care	Inactive	No clamping
H	COMPOSITE SYNC input	L	Active	Synchronous with NTSC
		H	Active	Synchronous with PAL

The clamp circuit is shown in Figure 6. The clamp voltage is stored on capacitor C2 during the back porch of the horizontal blanking period.

During the clamp pulse the input to channel A is clamped to:

$$V_C(A) = (16/256) \times (\text{voltage difference from terminal RT A to RB A})$$

$$V_C(B) = (128/256) \times (\text{voltage difference from terminal RT B to RB B})$$

$$V_C(C) = (128/256) \times (\text{voltage difference from terminal RT C to RB C})$$

COMPOSITE SYNC time monitoring

When CLPEN is high, COMPOSITE SYNC generates an internal clamp pulse on the horizontal blanking interval back porch. The TLC5733A has a timing window into which the horizontal sync tip must occur. There is a noise time window for the falling edge and one for the rising edge (see Figure 1, Figure 2, and Table 3).

correct COMPOSITE SYNC timing

The noise gate 1 signal provides the timing window for the COMPOSITE SYNC falling edge. After an interval A of 867 clocks for NTSC or 1075 for PAL from the last falling edge of COMPOSITE SYNC, noise gate 1 signal goes high for 43 clocks for NTSC or 61 clocks for PAL (interval B). The falling edge of the input signal to the EXTCLP terminal can occur at any time within this window to be a valid COMPOSITE SYNC falling edge.

The noise gate 2 signal provides the timing window for the COMPOSITE SYNC rising edge. On the falling edge of the horizontal sync tip, the internal logic generates noise gate 2 as a low signal for 58 clocks (interval C) for both NTSC and PAL and then returns to a high active state. At this time if the input to EXTCLP is still low, it is considered a valid COMPOSITE SYNC signal.

normal clamp pulse generation

On the rising edge of COMPOSITE SYNC, the internal logic generates an internal delay (interval D) and then generates the internal positive clamp pulse 54 clocks wide (interval F).

clamp operation with incorrect COMPOSITE SYNC timing

noise suppression

If the input to EXTCLP goes low prior to noise gate 1 going high (within 43 clocks for NTSC or 61 clocks for PAL of the normal 1H timing for the falling edge of COMPOSITE SYNC) then that input is not considered a valid COMPOSITE SYNC and is ignored.

If the input to EXTCLP is high when noise gate 2 goes to the high state, the input signal is considered noise and is ignored.

Therefore, the correct signal must be high for a maximum of 43 clocks for NTSC or 61 clocks for PAL, before the 1H timing, to be a valid sync signal. Also, the input to EXTCLP must be at least 58 clocks wide (interval C) to be valid.

This function of monitoring the timing eliminates spurious noise spikes from falsely synchronizing the system.

detailed description (continued)

timing error of COMPOSITE SYNC

The internal counter resets to zero on the first falling edge of COMPOSITE SYNC. After that time, if there is a missing COMPOSITE SYNC signal, then the internal logic waits an interval of 76 clocks (interval E) for NTSC or 93 for PAL from the counter zero count and then generates an internal clamp pulse 54 clocks wide (interval F).

This function maintains the synchronization pattern when COMPOSITE SYNC is not present.

summary of device operation with COMPOSITE SYNC

This internal timing allows the TLC5733A to correctly position the clamp pulse when an external COMPOSITE SYNC input:

- Is delayed with respect to the horizontal sync period
- Is early with respect to the horizontal sync period
- Is nonexistent during the horizontal sync period
- Has falling edge noise spikes within the horizontal sync period

The device operation is summarized as follows for these improper external clamp conditions:

- Under all four conditions on EXTCLP, the internal clamp generation circuit generates a clamp pulse at the proper time after the horizontal sync period as shown in Figure 1.
- The TLC5733A internal clamp circuit generates an internal clamp pulse each 1H time for the entire time interval that the COMPOSITE SYNC input is missing.

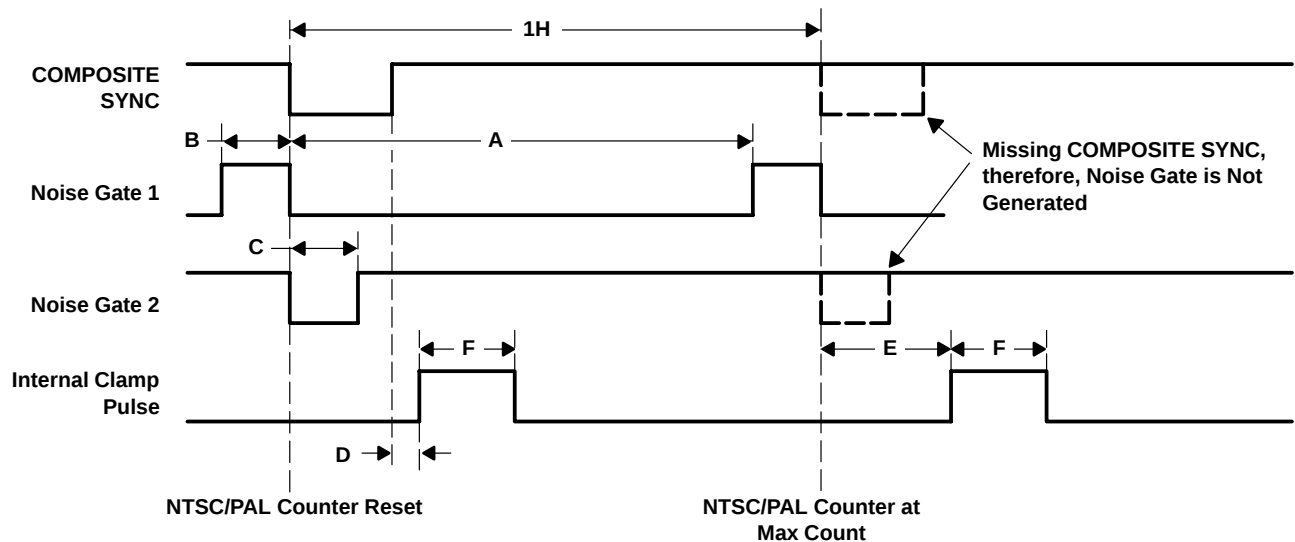


Figure 1. COMPOSITE SYNC and Internal Clamp Timing

TLC5733A

20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER

WITH HIGH-PRECISION CLAMP

SLAS104B – JULY 1995 – REVISED FEBRUARY 2001

summary of device operation with COMPOSITE SYNC (continued)

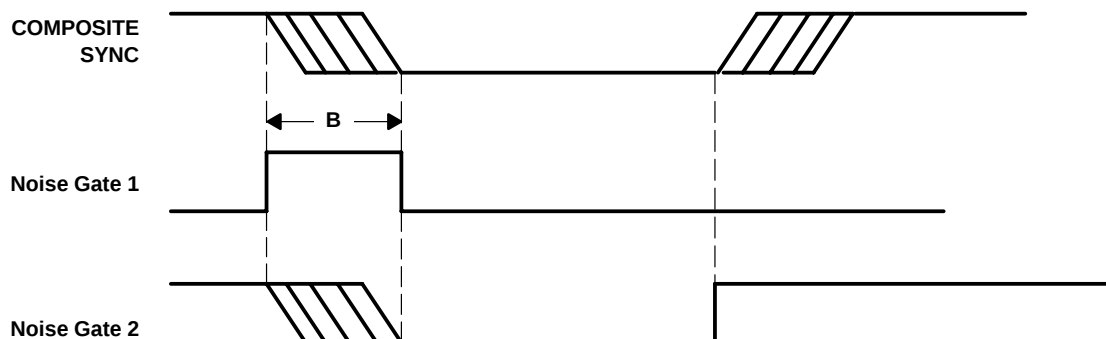


Figure 2. Proper COMPOSITE SYNC Timing

Table 3. Sync and Clamp Timing for NTSC and PAL With CLK = 4 fsc

TIME INTERVAL	NTSC fsc = 3.58 MHz		PAL fsc = 4.43 MHz	
	NO. OF CLOCKS	TIME (μs)	NO. OF CLOCKS	TIME (μs)
A	867	60.6	1075	60.7
B	43	3	61	3.5
C	58	4.05	58	3.27
D	6	0.42	6	0.34
E	76	5.3	93	5.25
F	54	3.77	84	4.74

using an external clamp pulse

When CLPEN is taken low, EXTCLP accepts an externally generated active-high clamp pulse. This pulse must occur within the horizontal-blanking interval back porch. CLPEN low inhibits the internal counters and no internal clamp pulse is generated.

output digital code (for each channel of ADC)

Table 4. Input Signal Versus Digital Output Code

INPUT SIGNAL VOLTAGE	STEP	DIGITAL OUTPUT CODE							
		MSB							
V _{ref} (RT)	255	1	1	1	1	1	1	1	1
•	•	•	•	•	•	•	•	•	•
•	•	•	•	•	•	•	•	•	•
•	128	1	0	0	0	0	0	0	0
•	127	0	1	1	1	1	1	1	1
•	•	•	•	•	•	•	•	•	•
•	•	•	•	•	•	•	•	•	•
V _{ref} (RB)	0	0	0	0	0	0	0	0	0

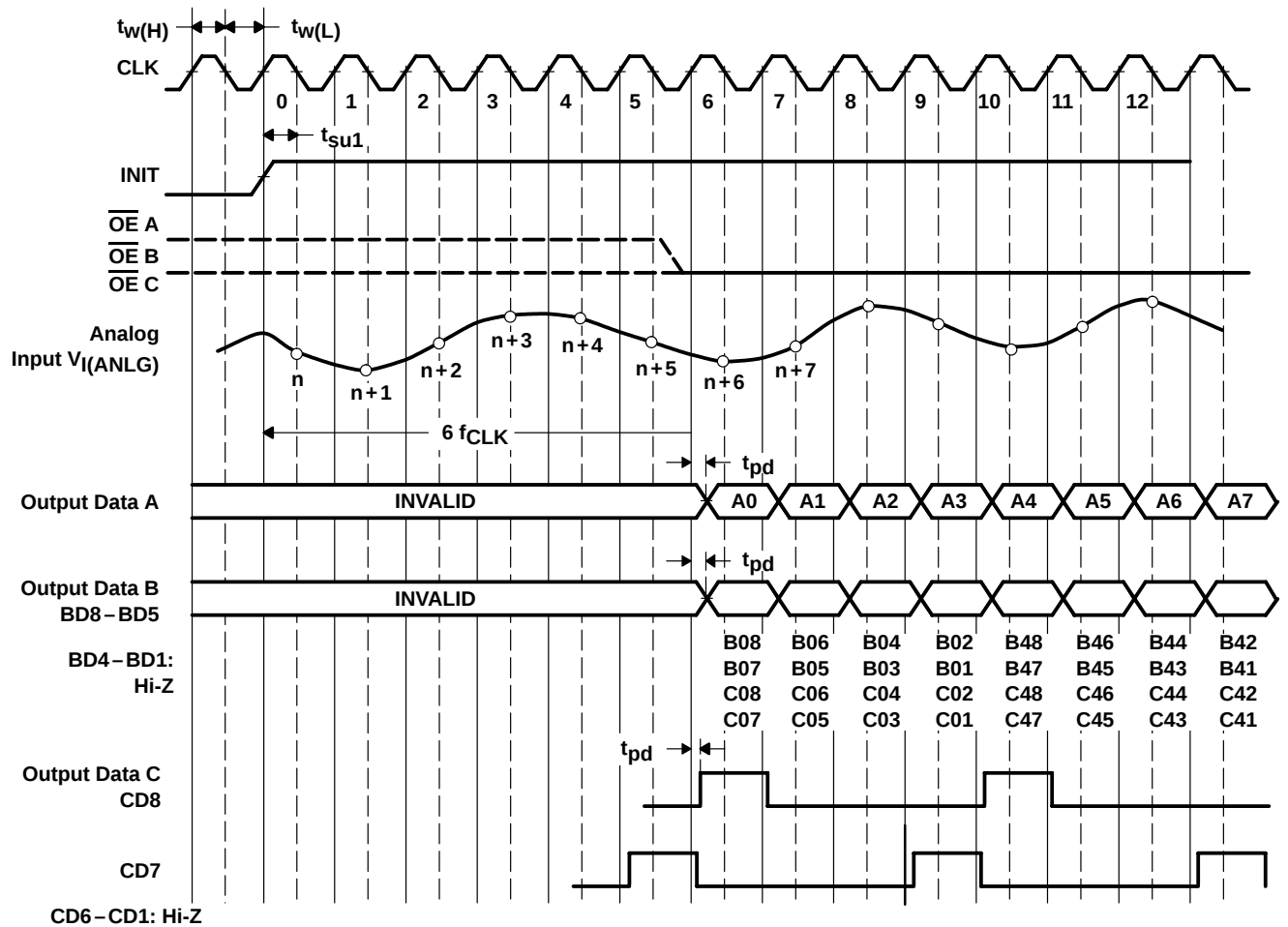
detailed description (continued)

output data format

The TLC5733A can select three output data formats to various TV/VCR (video) data processing by the combination of MODE0 and MODE1. The output is synchronous when INIT is taken high.

Table 5. Output Data Format Selection

CONDITION		OUTPUT DATA	
MODE1	MODE0	OUTPUT DATA FORMAT	RATIO OF Y:U:V
L	L	Format 1	4:1:1
L	H	Format 2	4:4:4
H	L	Format 3	4:2:2
H	H	Not used	N/A



○ = Input signal sampling point

Figure 3. Format 1, 4:1:1

TLC5733A
20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER
WITH HIGH-PRECISION CLAMP

SLAS104B – JULY 1995 – REVISED FEBRUARY 2001

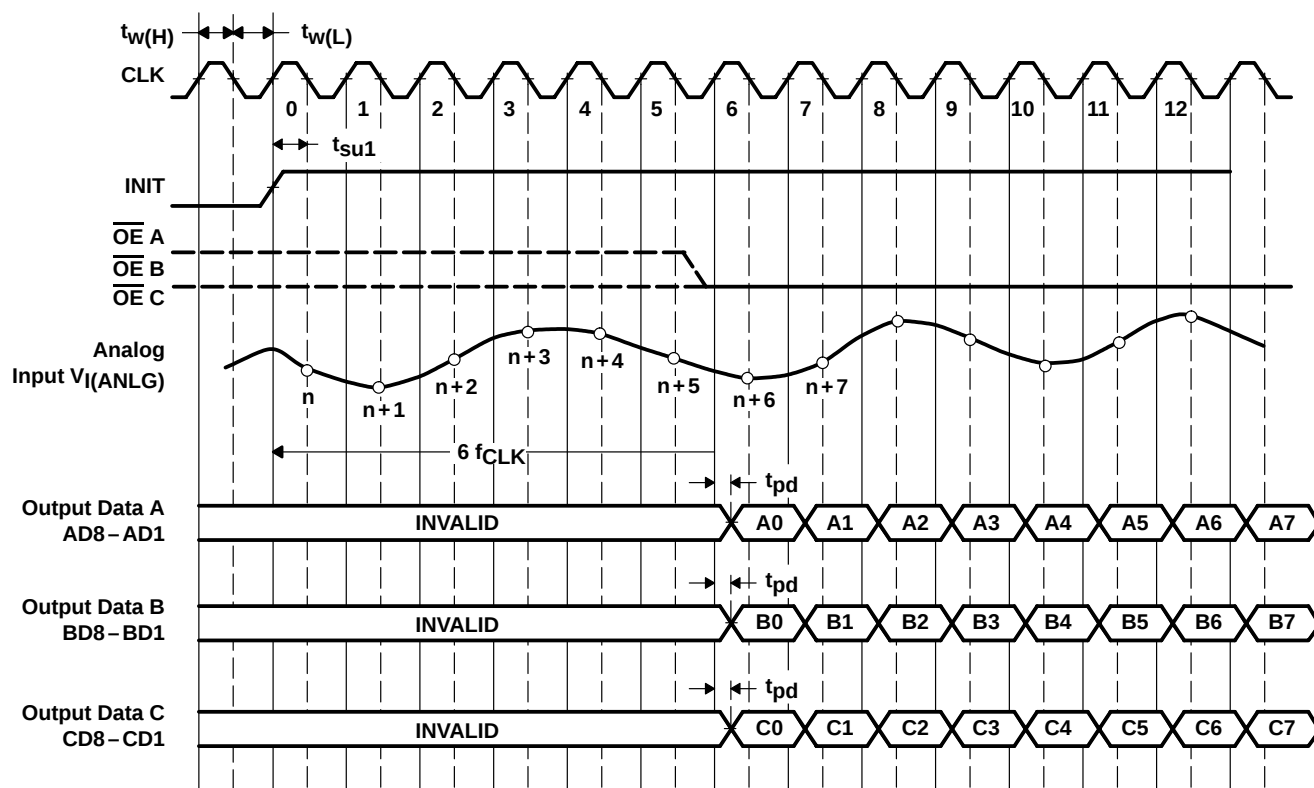
output data format (continued)

Table 6. Format 1

CHANNEL OF ADC	BIT	OUTPUT DATA							
		CLK (see Note 1)							
		6	7	8	9	10	11	12	13
A	AD8	A08	A18	A28	A38	A48	A58	A68	A78
	AD7	A07	A17	A27	A37	A47	A57	A67	A77
	AD6	A06	A16	A26	A36	A46	A56	A66	A76
	AD5	A05	A15	A25	A35	A45	A55	A65	A75
	AD4	A04	A14	A24	A34	A44	A54	A64	A74
	AD3	A03	A13	A23	A33	A43	A53	A63	A73
	AD2	A02	A12	A22	A32	A42	A52	A62	A72
	AD1	A01	A11	A21	A31	A41	A51	A61	A71
B	BD8	B08	B06	B04	B02	B48	B46	B44	B42
	BD7	B07	B05	B03	B01	B47	B45	B43	B41
	BD6	C08	C06	C04	C02	C48	C46	C44	C42
	BD5	C07	C05	C03	C01	C47	C45	C43	C41
	BD4	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
	BD3	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
	BD2	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
	BD1	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
C	CD8	H	L	L	L	H	L	L	L
	CD7	L	L	L	H	L	L	L	H
	CD6	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
	CD5	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
	CD4	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
	CD3	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
	CD2	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
	CD1	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z

- NOTES: 1. The value of the first sampling clock at A/D conversion is CLK 0.
2. A06 is an example of an entry in the table where A is the ADC channel, 0 is the sampling order, and 6 is the bit number.

output data format (continued)



○ = Input signal sampling point

Figure 4. Format 2, 4:4:4

TLC5733A
20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER
WITH HIGH-PRECISION CLAMP

SLAS104B – JULY 1995 – REVISED FEBRUARY 2001

output data format (continued)

Table 7. Format 2

CHANNEL OF ADC	BIT	OUTPUT DATA							
		CLK (see Note 1)							
		6	7	8	9	10	11	12	13
A	AD8	A08	A18	A28	A38	A48	A58	A68	A78
	AD7	A07	A17	A27	A37	A47	A57	A67	A77
	AD6	A06	A16	A26	A36	A46	A56	A66	A76
	AD5	A05	A15	A25	A35	A45	A55	A65	A75
	AD4	A04	A14	A24	A34	A44	A54	A64	A74
	AD3	A03	A13	A23	A33	A43	A53	A63	A73
	AD2	A02	A12	A22	A32	A42	A52	A62	A72
	AD1	A01	A11	A21	A31	A41	A51	A61	A71
B	BD8	B08	B18	B28	B38	B48	B58	B68	B78
	BD7	B07	B17	B27	B37	B47	B57	B67	B77
	BD6	B06	B16	B26	B36	B46	B56	B66	B76
	BD5	B05	B15	B25	B35	B45	B55	B65	B75
	BD4	B04	B14	B24	B34	B44	B54	B64	B74
	BD3	B03	B13	B23	B33	B43	B53	B63	B73
	BD2	B02	B12	B22	B32	B42	B52	B62	B72
	BD1	B01	B11	B21	B31	B41	B51	B61	B71
C	CD8	C08	C18	C28	C38	C48	C58	C68	C78
	CD7	C07	C17	C27	C37	C47	C57	C67	C77
	CD6	C06	C16	C26	C36	C46	C56	C66	C76
	CD5	C05	C15	C25	C35	C45	C55	C65	C75
	CD4	C04	C14	C24	C34	C44	C54	C64	C74
	CD3	C03	C13	C23	C33	C43	C53	C63	C73
	CD2	C02	C12	C22	C32	C42	C52	C62	C72
	CD1	C01	C11	C21	C31	C41	C51	C61	C71

NOTES: 1. The value of the first sampling clock at A/D conversion is CLK 0.
2. A06 is an example of an entry in the table where A is the ADC channel, 0 is the sampling order, and 6 is the bit number.

output data format (continued)

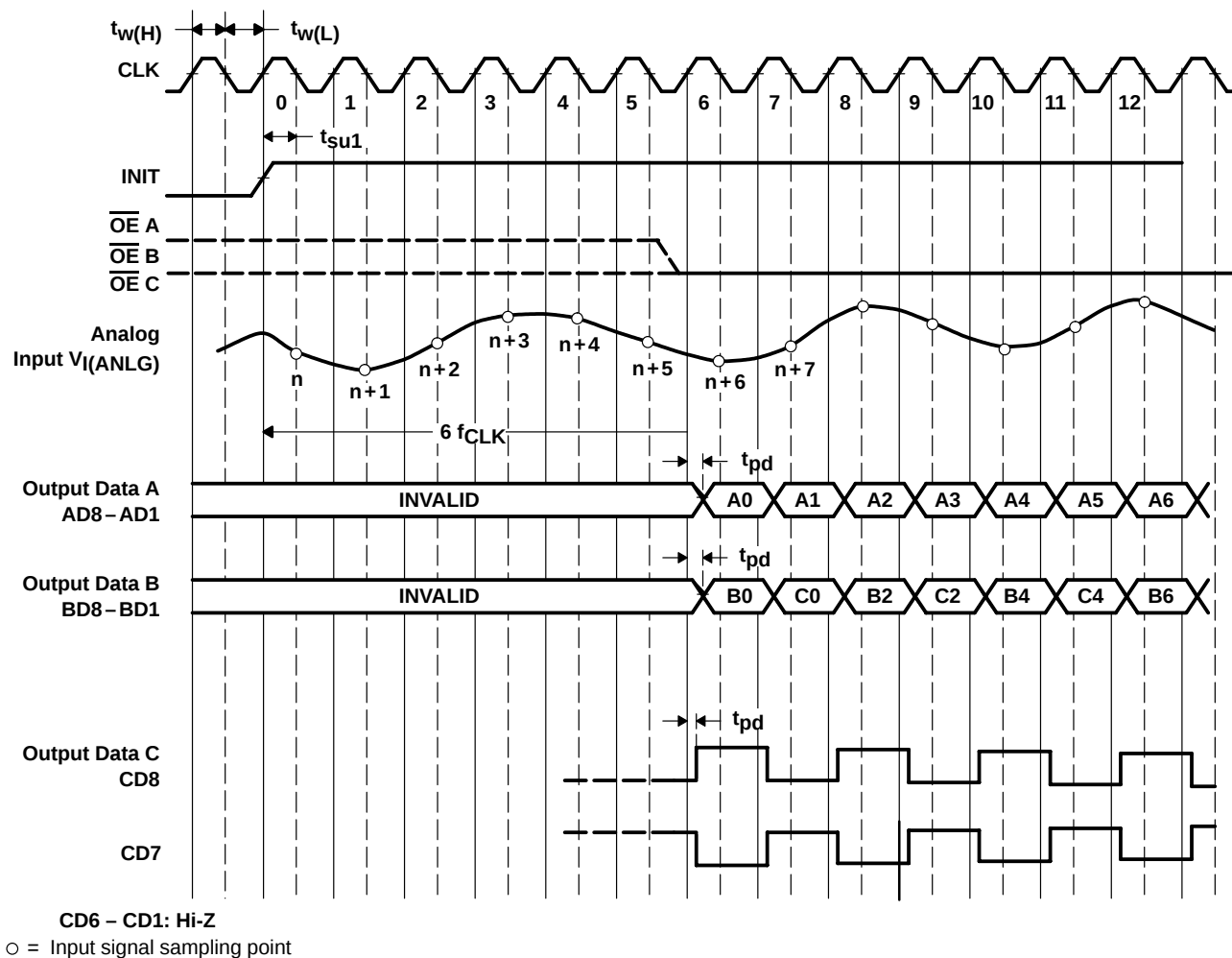


Figure 5. Format 3, 4:2:2

TLC5733A
20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER
WITH HIGH-PRECISION CLAMP

SLAS104B – JULY 1995 – REVISED FEBRUARY 2001

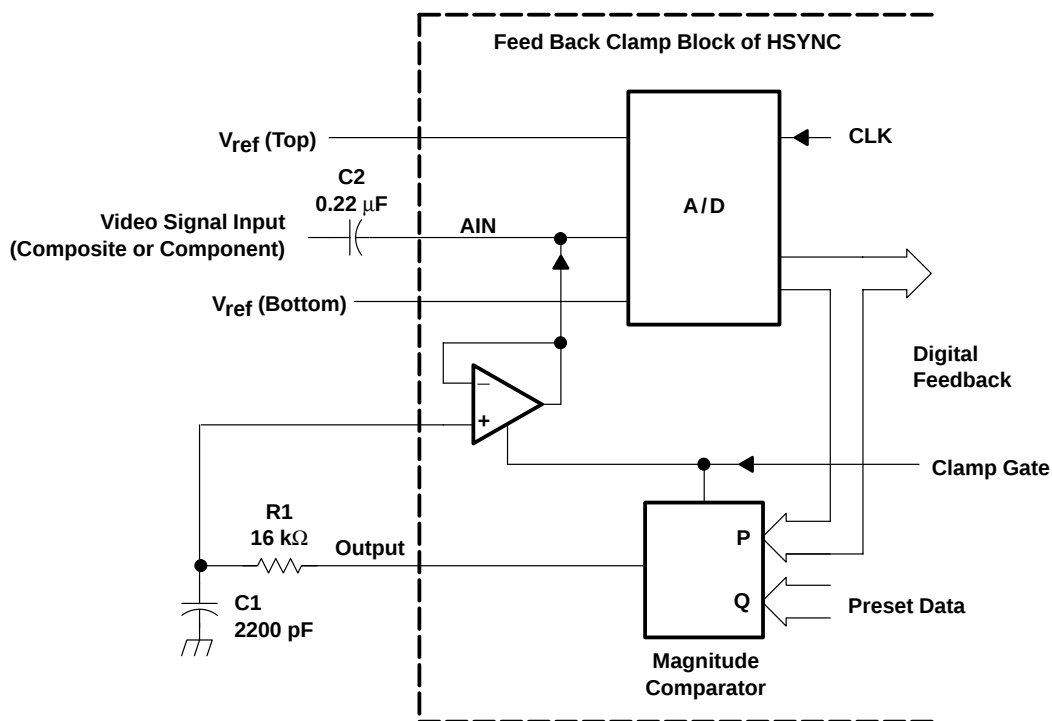
output data format (continued)

Table 8. Format 3

CHANNEL OF ADC	BIT	OUTPUT DATA							
		CLK (see Note 1)							
		6	7	8	9	10	11	12	13
A	AD8	A08	A18	A28	A38	A48	A58	A68	A78
	AD7	A07	A17	A27	A37	A47	A57	A67	A77
	AD6	A06	A16	A26	A36	A46	A56	A66	A76
	AD5	A05	A15	A25	A35	A45	A55	A65	A75
	AD4	A04	A14	A24	A34	A44	A54	A64	A74
	AD3	A03	A13	A23	A33	A43	A53	A63	A73
	AD2	A02	A12	A22	A32	A42	A52	A62	A72
	AD1	A01	A11	A21	A31	A41	A51	A61	A71
B	BD8	B08	C08	B28	C28	B48	C48	B68	C68
	BD7	B07	C07	B27	C27	B47	C47	B67	C67
	BD6	B06	C06	B26	C26	B46	C46	B66	C66
	BD5	B05	C05	B25	C25	B45	C45	B65	C65
	BD4	B04	C04	B24	C24	B44	C44	B64	C64
	BD3	B03	C03	B23	C23	B43	C43	B63	C63
	BD2	B02	C02	B22	C22	B42	C42	B62	C62
	BD1	B01	C01	B21	C21	B41	C41	B61	C61
C	CD8	H	L	H	L	H	L	H	L
	CD7	L	H	L	H	L	H	L	H
	CD6	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
	CD5	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
	CD4	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
	CD3	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
	CD2	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
	CD1	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z

NOTES: 1. The value of the first sampling clock at A/D conversion is CLK 0.
2. A06 is an example of an entry in the table where A is the ADC channel, 0 is the sampling order, and 6 is the bit number.

APPLICATION INFORMATION



FEEDBACK CLAMP AND CHARGE PUMP ACTIVITY

INPUT DATA CONDITIONS	OUTPUT		CHARGE PUMP CONDITIONS
$P < Q$	Active	H	Charge
$P = Q$	Hold	Z	Hold
$P > Q$	Active	L	Discharge

Figure 6. Feedback Clamp Circuit

TLC5733A

20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER WITH HIGH-PRECISION CLAMP

SLAS104B – JULY 1995 – REVISED FEBRUARY 2001

APPLICATION INFORMATION

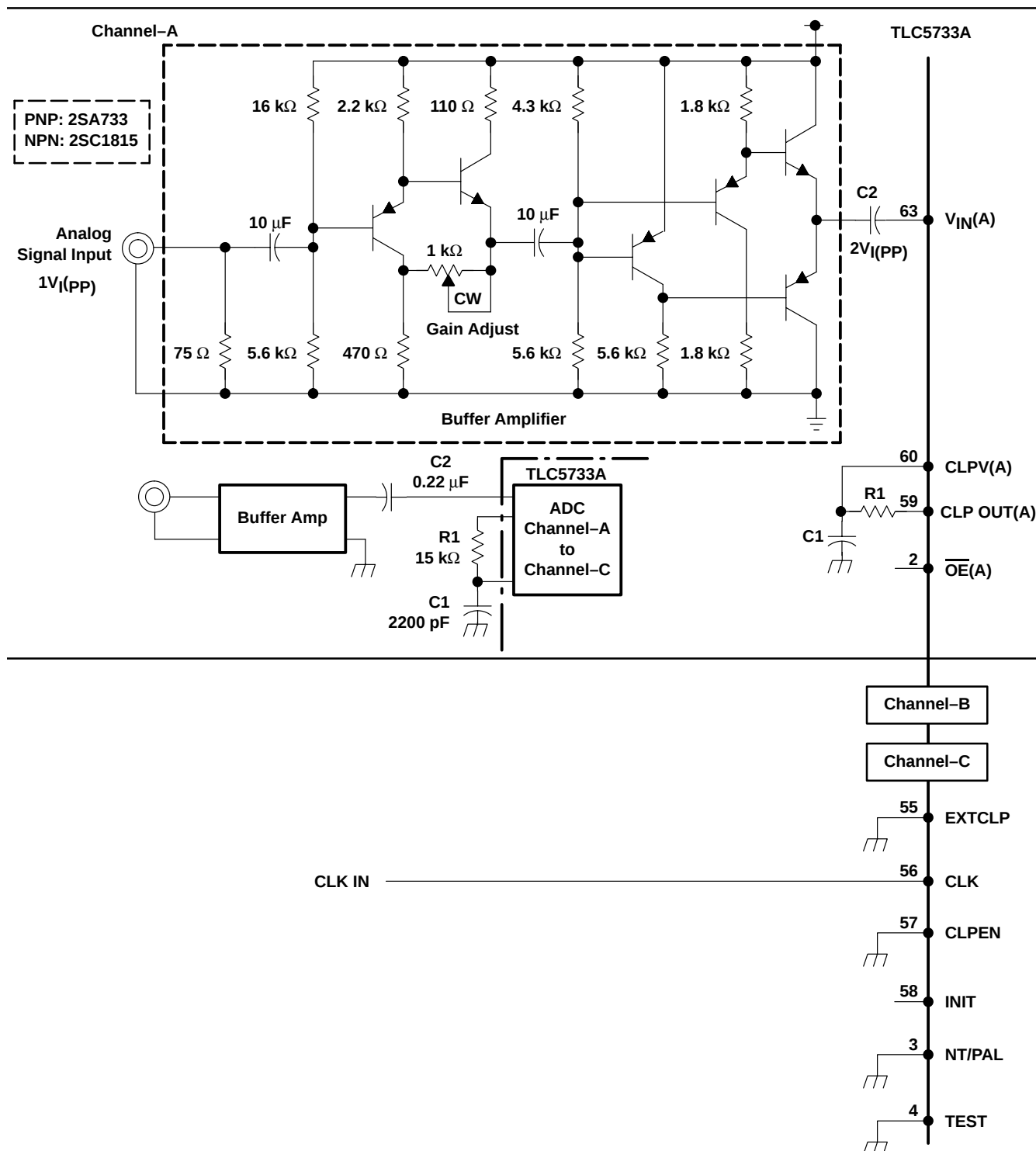


Figure 7. Interface Without Clamping

TLC5733A

20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER WITH HIGH-PRECISION CLAMP

SLAS104B – JULY 1995 – REVISED FEBRUARY 2001

APPLICATION INFORMATION

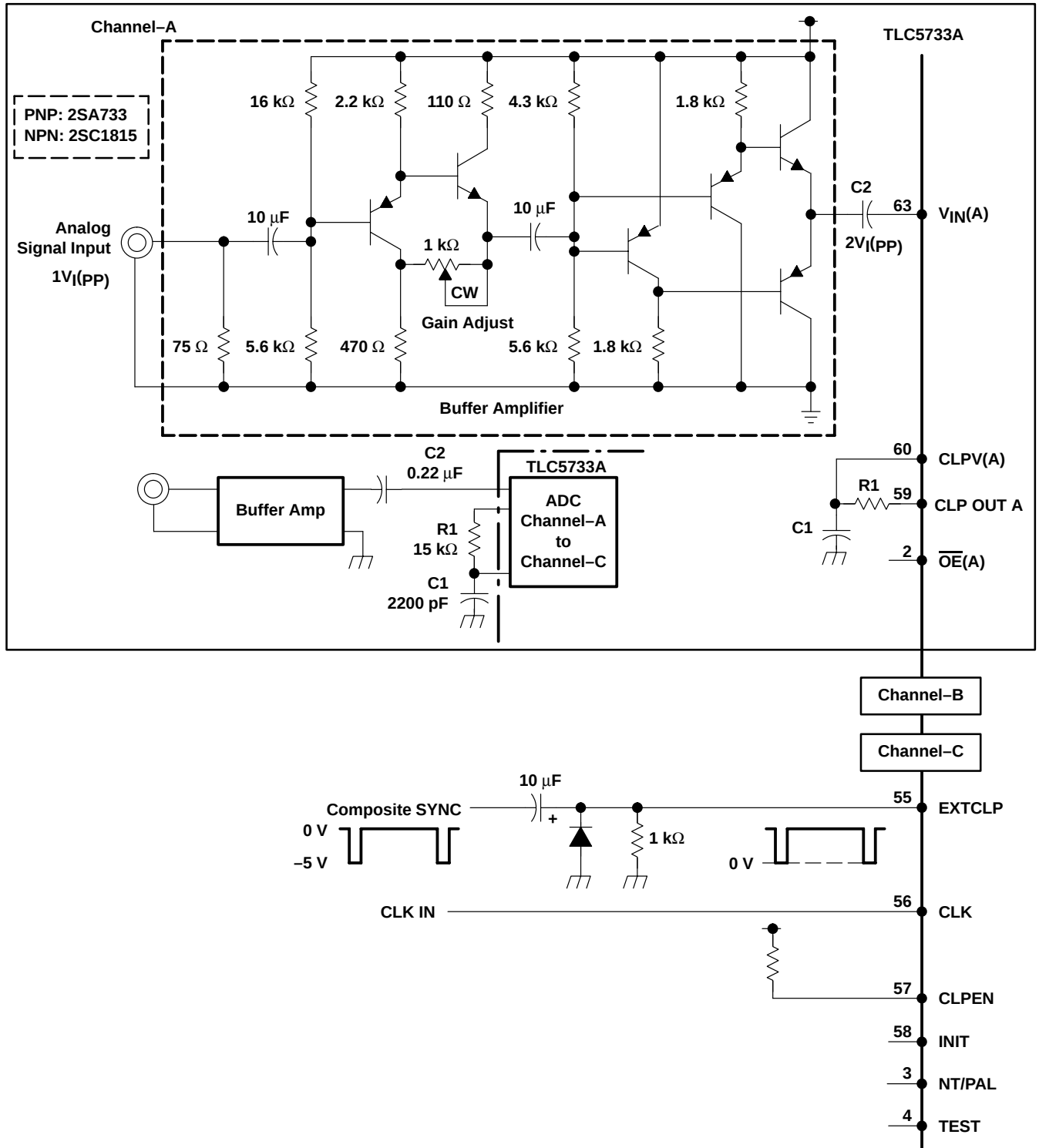


Figure 8. Interface Connection Using Composite Sync Signal

TLC5733A

20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER WITH HIGH-PRECISION CLAMP

SLAS104B – JULY 1995 – REVISED FEBRUARY 2001

APPLICATION INFORMATION

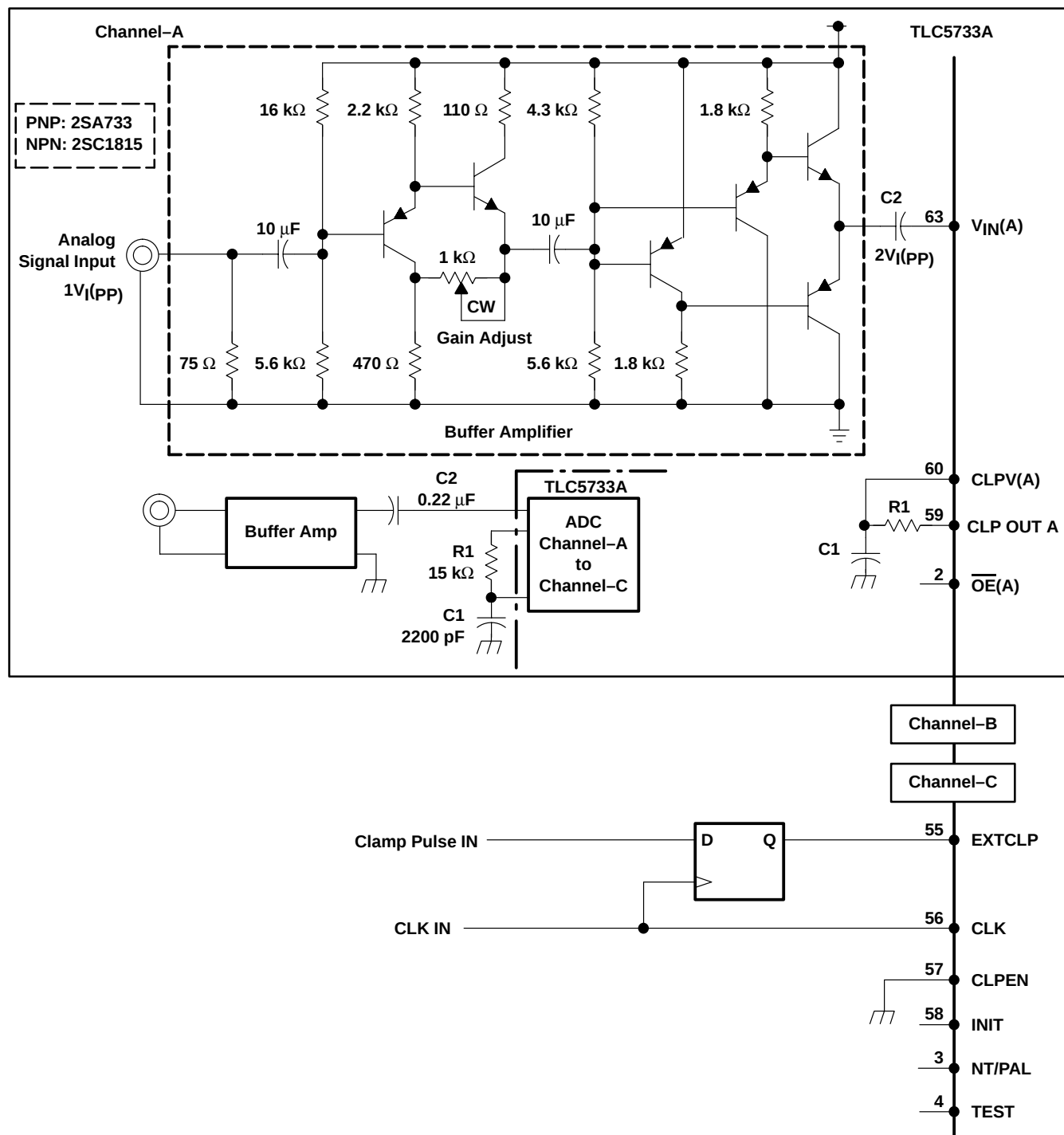


Figure 9. Interface Using External Clamp Pulse With Synchronization

APPLICATION INFORMATION

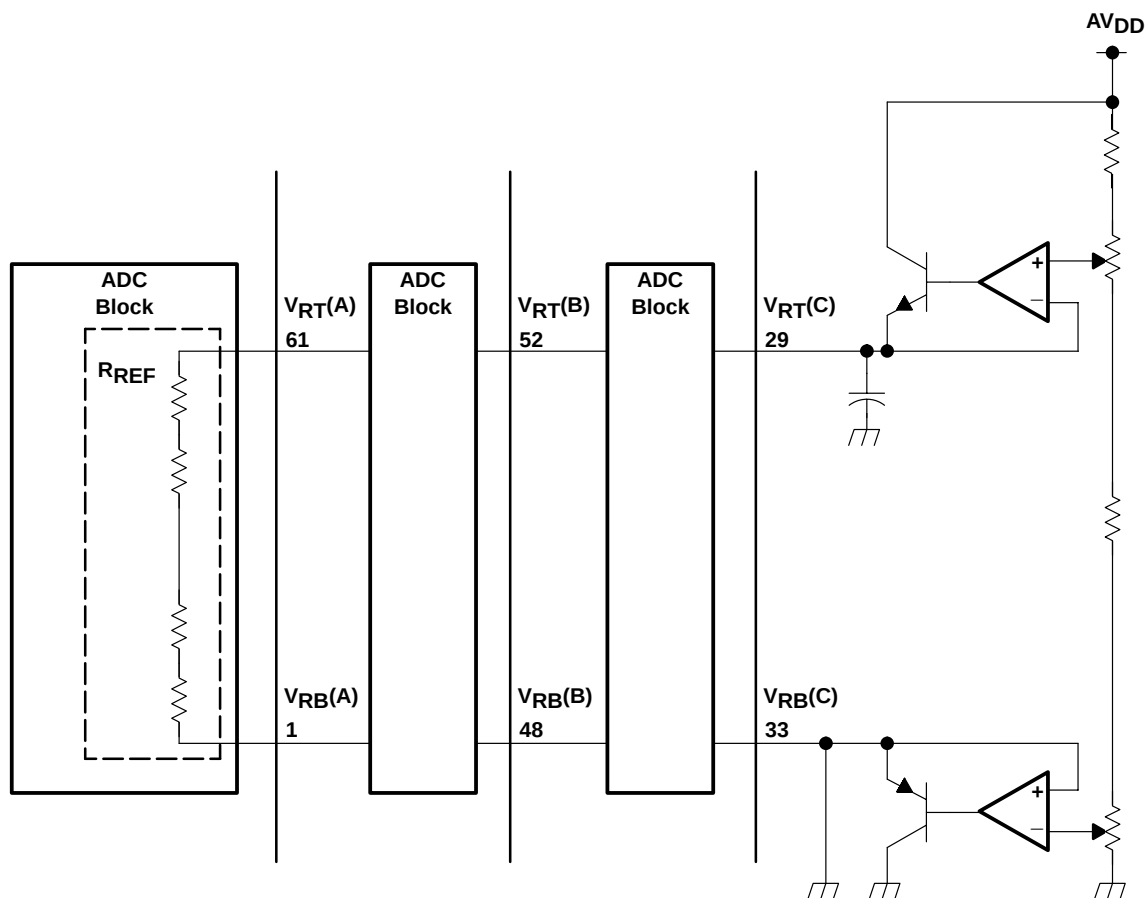


Figure 10. Adjustment Circuit For Top and Bottom Reference Voltages

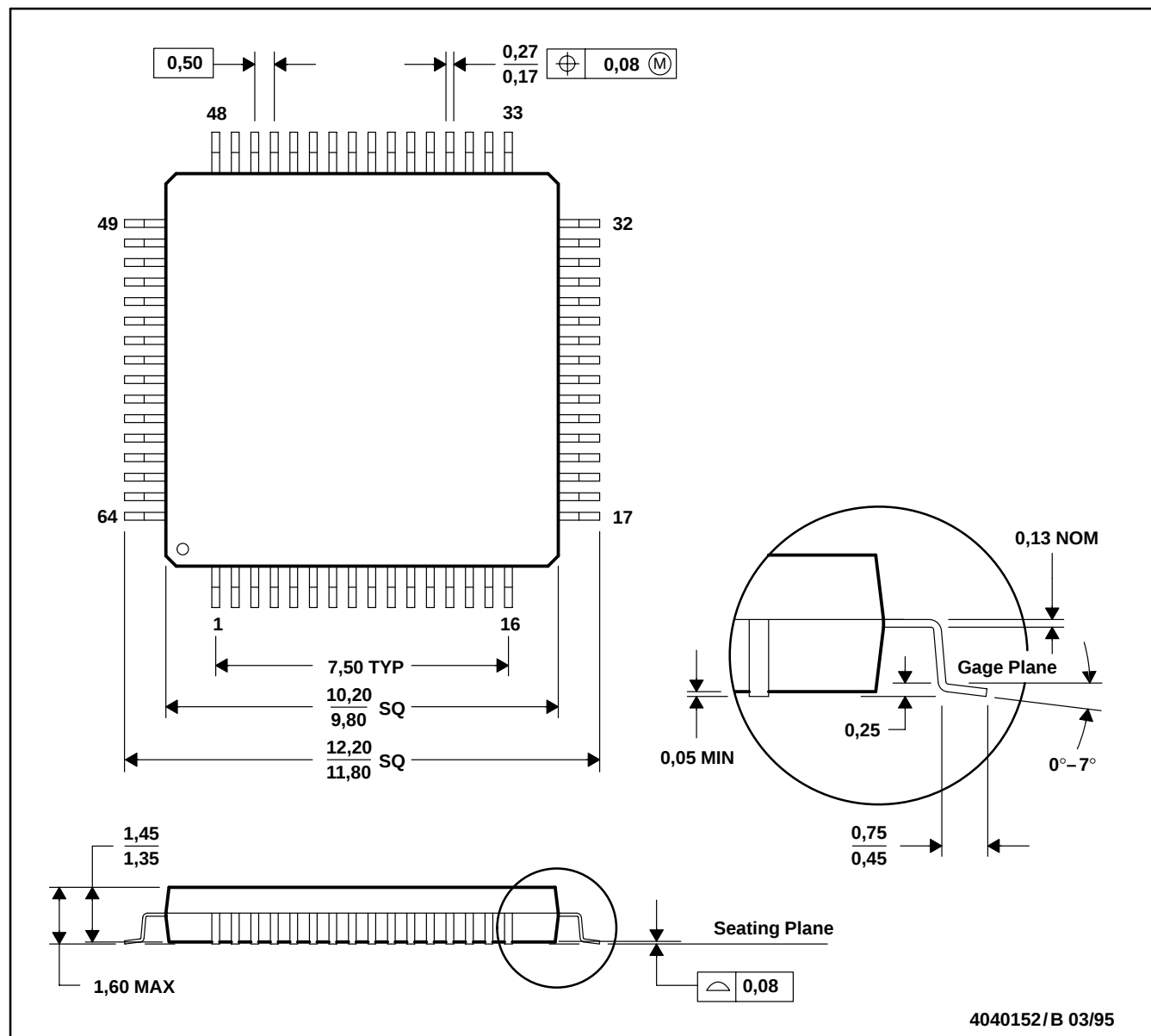
TLC5733A
20 MSPS 3-CHANNEL ANALOG-TO-DIGITAL CONVERTER
WITH HIGH-PRECISION CLAMP

SLAS104B – JULY 1995 – REVISED FEBRUARY 2001

MECHANICAL DATA

PM (S-PQFP-G64)

PLASTIC QUAD FLATPACK



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Falls within JEDEC MO-136

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TLC5733AIPM	OBSOLETE	LQFP	PM	64		TBD	Call TI	Call TI
TLC5733IPM	OBSOLETE	LQFP	PM	64		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265

Copyright © 2005, Texas Instruments Incorporated